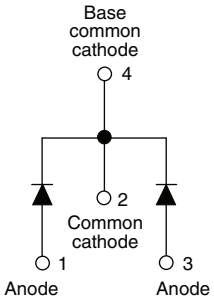
# Ultrafast Rectifier, 2 x 3 A FRED Pt®

D-PAK (TO-252AA)




## FEATURES

- Ultrafast recovery time
- Low forward voltage drop
- Low leakage current
- 175 °C operating junction temperature
- Compliant to RoHS Directive 2002/95/EC
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

RoHS COMPLIANT

## DESCRIPTION/APPLICATIONS

VS-MURD620CTPbF is the state of the art ultrafast recovery rectifier specifically designed with optimized performance of forward voltage drop and ultrafast recovery time.
The planar structure and the platinum doped life time control, guarantee the best overall performance, ruggedness and reliability characteristics.
These devices are intended for use in the output rectification stage of SMPS, UPS, DC/DC converters as well as freewheeling diode in low voltage inverters and chopper motor drives.
Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

| PRODUCT SUMMARY | |
|---|---|
| Package | D-PAK (TO-252AA) |
| $I_{F(AV)}$ | 2 x 3 A |
| $V_R$ | 200 V |
| $V_F$ at $I_F$ | 1.0 V |
| $t_{rr}$ typ. | See Recovery table |
| $T_J$ max. | 175 °C |
| Diode variation | Common cathode |

| ABSOLUTE MAXIMUM RATINGS | | | | |
|---|---|---|---|---|
| PARAMETER | SYMBOL | TEST CONDITIONS | MAX. | UNITS |
| Peak repetitive reverse voltage | $V_{RRM}$ | | 200 | V |
| Average rectified forward current per device | $I_{F(AV)}$ | Total device, rated $V_R$, $T_C$ = 146 °C | 6 | A |
| Non-repetitive peak surge current | $I_{FSM}$ | | 50 | |
| Peak repetitive forward current per diode | $I_{FM}$ | Rated $V_R$, square wave, 20 kHz, $T_C$ = 146 °C | 6 | |
| Operating junction and storage temperatures | $T_J$, $T_{Stg}$ | | - 65 to 175 | °C |

| ELECTRICAL SPECIFICATIONS ($T_J$ = 25 °C unless otherwise specified) | | | | | | |
|---|---|---|---|---|---|---|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Breakdown voltage, blocking voltage | $V_{BR}$, $V_R$ | $I_R$ = 100 µA | 200 | - | - | V |
| Forward voltage | $V_F$ | $I_F$ = 3 A | - | - | 1.0 | |
| | | $I_F$ = 3 A, $T_J$ = 125 °C | - | - | 0.96 | |
| | | $I_F$ = 6 A | - | - | 1.2 | |
| | | $I_F$ = 6 A, $T_J$ = 125 °C | - | - | 1.13 | |
| Reverse leakage current | $I_R$ | $V_R$ = $V_R$ rated | - | - | 5 | µA |
| | | $T_J$ = 125 °C, $V_R$ = $V_R$ rated | - | - | 250 | |
| Junction capacitance | $C_T$ | $V_R$ = 200 V | - | 12 | - | pF |
| Series inductance | $L_S$ | Measured lead to lead 5 mm from package body | - | 8.0 | - | nH |

| DYNAMIC RECOVERY CHARACTERISTICS ($T_J$ = 25 °C unless otherwise specified) | | | | | | | |
|---|---|---|---|---|---|---|---|
| **PARAMETER** | **SYMBOL** | **TEST CONDITIONS** | | **MIN.** | **TYP.** | **MAX.** | **UNITS** |
| Reverse recovery time | $t_{rr}$ | $I_F$ = 1.0 A, $dI_F/dt$ = 50 A/μs, $V_R$ = 30 V | | - | - | 35 | ns |
| | | $I_F$ = 0.5 A, $I_R$ = 1.0 A, $I_{REC}$ = 0.25 A | | - | - | 25 | |
| | | $T_J$ = 25 °C | $I_F$ = 3 A<br>$dI_F/dt$ = 200 A/μs<br>$V_R$ = 160 V | - | 19 | - | |
| | | $T_J$ = 125 °C | | - | 26 | - | |
| Peak recovery current | $I_{RRM}$ | $T_J$ = 25 °C | | - | 3.1 | - | A |
| | | $T_J$ = 125 °C | | - | 4.6 | - | |
| Reverse recovery charge | $Q_{rr}$ | $T_J$ = 25 °C | | - | 30 | - | nC |
| | | $T_J$ = 125 °C | | - | 60 | - | |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | |
|---|---|---|---|---|---|---|
| **PARAMETER** | **SYMBOL** | **TEST CONDITIONS** | **MIN.** | **TYP.** | **MAX.** | **UNITS** |
| Maximum junction and storage temperature range | $T_J$, $T_{Stg}$ | | - 65 | - | 175 | °C |
| Thermal resistance, junction to case per leg | $R_{thJC}$ | | - | - | 9.0 | °C/W |
| Thermal resistance, junction to ambient per leg | $R_{thJA}$ | | - | - | 80 | |
| Thermal resistance, case to heatsink | $R_{thCS}$ | Mounting surface, flat, smooth and greased | - | - | - | |
| Weight | | | - | 0.3 | - | g |
| | | | - | 0.01 | - | oz. |
| Mounting torque | | | 6.0 (5.0) | - | 12 (10) | kgf · cm (lbf · in) |
| Marking device | | Case style D-PAK | MURD620CT | | | |

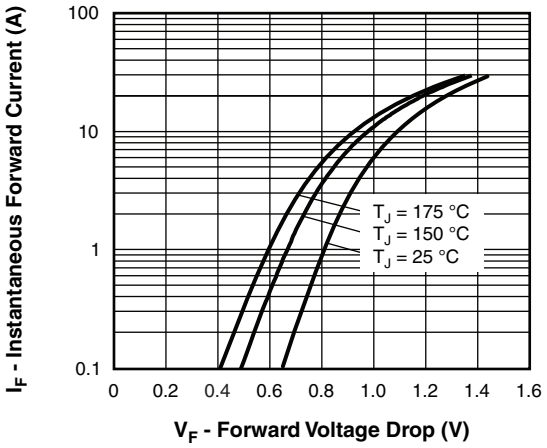



Fig. 1 - Typical Forward Voltage Drop Characteristics

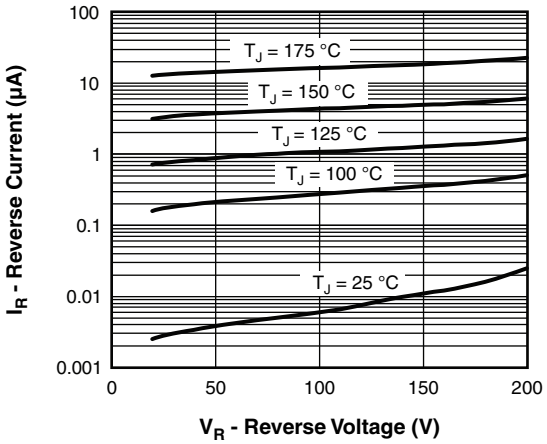



Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

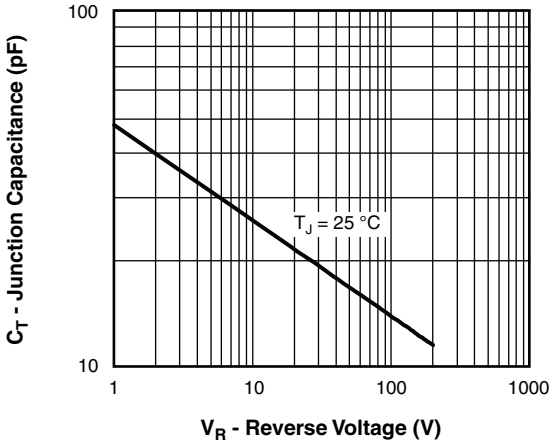



Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

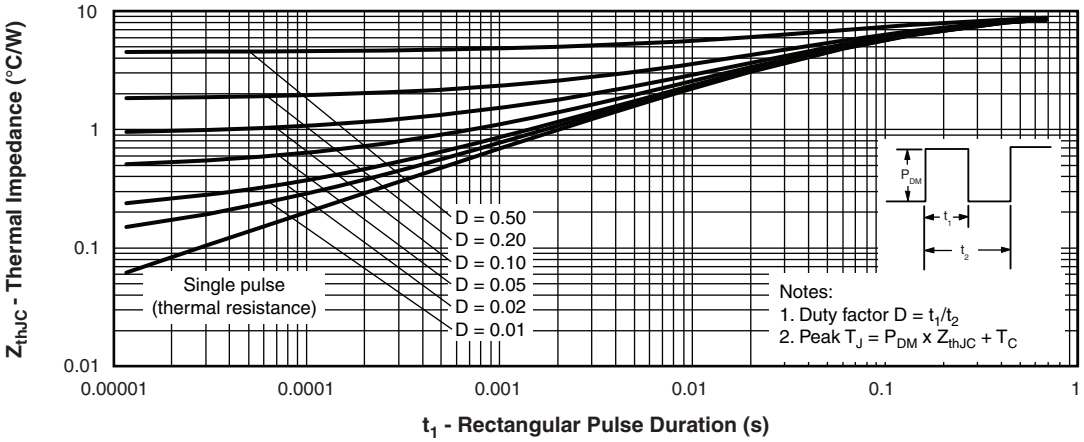



Fig. 4 - Maximum Thermal Impedance $Z_{thJC}$ Characteristics

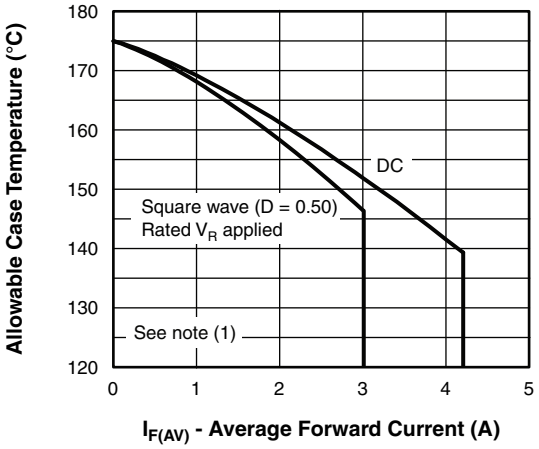



Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

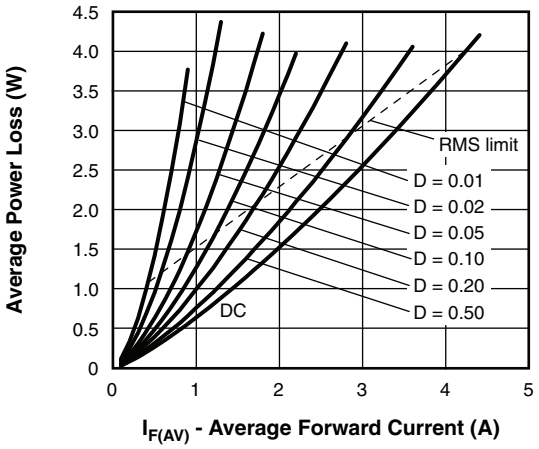



Fig. 6 - Forward Power Loss Characteristics

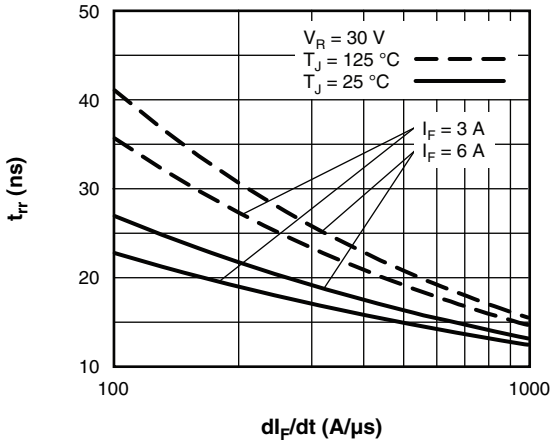



Fig. 7 - Typical Reverse Recovery Time vs. $dI_F/dt$

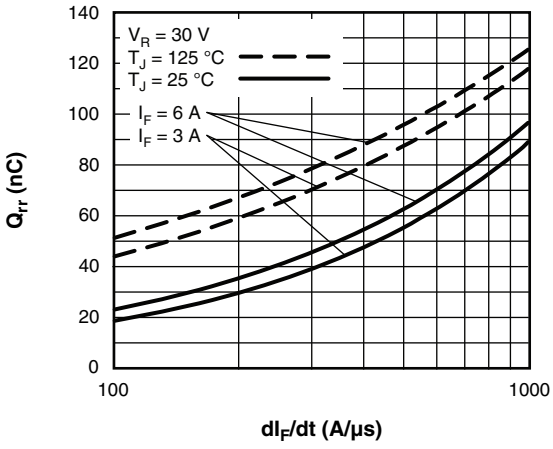



Fig. 8 - Typical Stored Charge vs. $dI_F/dt$

**Note**

(1) Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$;
Pd = Forward power loss = $I_{F(AV)} \times V_{FM}$ at ($I_{F(AV)}/D$) (see fig. 6);
$Pd_{REV}$ = Inverse power loss = $V_{R1} \times I_R (1 - D)$; $I_R$ at $V_{R1}$ = Rated $V_R$

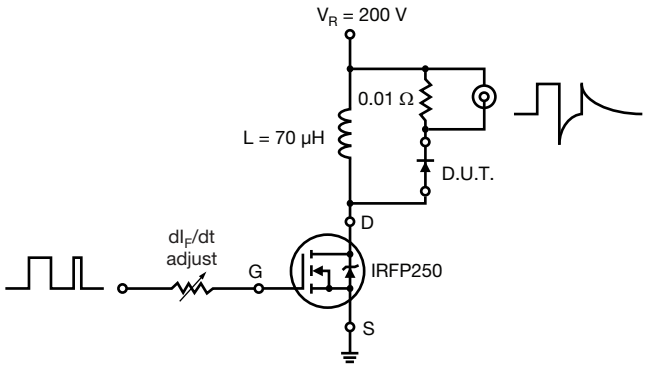
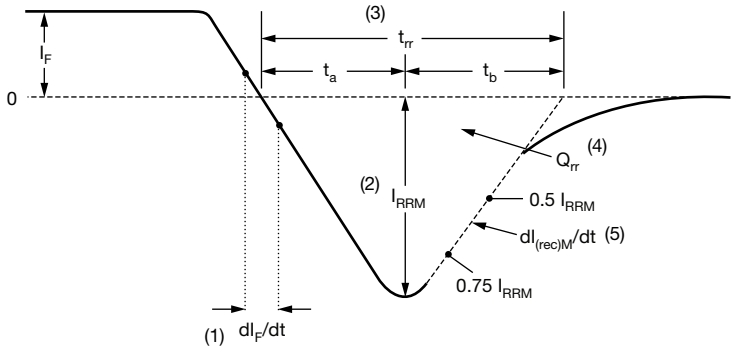



Fig. 9 - Reverse Recovery Parameter Test Circuit




(1) $dI_F/dt$ - rate of change of current through zero crossing

(2) $I_{RRM}$ - peak reverse recovery current

(3) $t_{rr}$ - reverse recovery time measured from zero crossing point of negative going $I_F$ to point where a line passing through 0.75 $I_{RRM}$ and 0.50 $I_{RRM}$ extrapolated to zero current.

(4) $Q_{rr}$ - area under curve defined by $t_{rr}$ and $I_{RRM}$

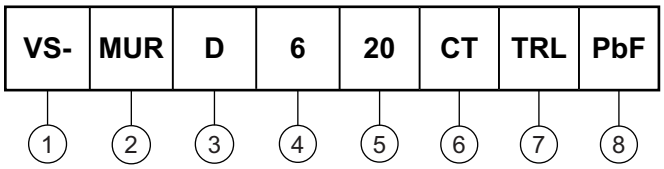
$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) $dI_{(rec)M}/dt$ - peak rate of change of current during $t_b$ portion of $t_{rr}$

Fig. 10 - Reverse Recovery Waveform and Definitions

## ORDERING INFORMATION TABLE

Device code



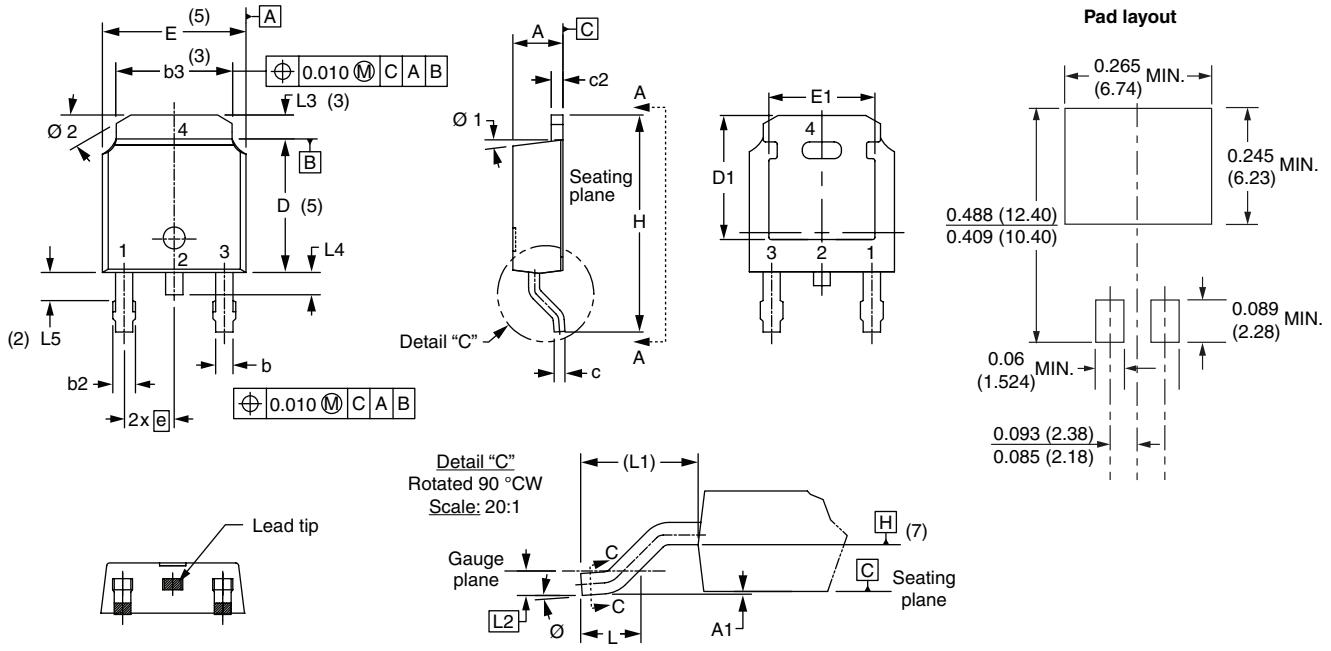

| | | |
|---|---|---|
| 1 | - | Vishay Semiconductors product |
| 2 | - | Ultrafast MUR series |
| 3 | - | D = D-PAK |
| 4 | - | Current rating (6 = 6 A) |
| 5 | - | Voltage rating (20 = 200 V) |
| 6 | - | CT = Center tap (dual) |
| 7 | - | Tape and reel suffix |
| 8 | - | PbF = Lead (Pb)-free |

7 - Tape and reel suffix:
TR = Tape and reel
TRL = Tape and reel (left oriented)
TRR = Tape and reel (right oriented)

| LINKS TO RELATED DOCUMENTS | |
|---|---|
| Dimensions | www.vishay.com/doc?95016 |
| Part marking information | www.vishay.com/doc?95059 |
| Packaging information | www.vishay.com/doc?95033 |

# D-PAK (TO-252AA)

**DIMENSIONS** in millimeters and inches




| SYMBOL | MILLIMETERS | | INCHES | | NOTES |
|---|---|---|---|---|---|
| | MIN. | MAX. | MIN. | MAX. | |
| A | 2.18 | 2.39 | 0.086 | 0.094 | |
| A1 | - | 0.13 | - | 0.005 | |
| b | 0.64 | 0.89 | 0.025 | 0.035 | |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 | |
| b3 | 4.95 | 5.46 | 0.195 | 0.215 | 3 |
| c | 0.46 | 0.61 | 0.018 | 0.024 | |
| c2 | 0.46 | 0.89 | 0.018 | 0.035 | |
| D | 5.97 | 6.22 | 0.235 | 0.245 | 5 |
| D1 | 5.21 | - | 0.205 | - | 3 |
| E | 6.35 | 6.73 | 0.250 | 0.265 | 5 |
| E1 | 4.32 | - | 0.170 | - | 3 |

| SYMBOL | MILLIMETERS | | INCHES | | NOTES |
|---|---|---|---|---|---|
| | MIN. | MAX. | MIN. | MAX. | |
| e | 2.29 BSC | | 0.090 BSC | | |
| H | 9.40 | 10.41 | 0.370 | 0.410 | |
| L | 1.40 | 1.78 | 0.055 | 0.070 | |
| L1 | 2.74 BSC | | 0.108 REF. | | |
| L2 | 0.51 BSC | | 0.020 BSC | | |
| L3 | 0.89 | 1.27 | 0.035 | 0.050 | 3 |
| L4 | - | 1.02 | - | 0.040 | |
| L5 | 1.14 | 1.52 | 0.045 | 0.060 | 2 |
| Ø | 0° | 10° | 0° | 10° | |
| Ø1 | 0° | 15° | 0° | 15° | |
| Ø2 | 25° | 35° | 25° | 35° | |

**Notes**

(1) Dimensioning and tolerancing as per ASME Y14.5M-1994

(2) Lead dimension uncontrolled in L5

(3) Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad

(4) Section C - C dimension apply to the flat section of the lead between 0.13 and 0.25 mm (0.005 and 0.10") from the lead tip

(5) Dimension D, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

(6) Dimension b1 and c1 applied to base metal only

(7) Datum A and B to be determined at datum plane H

(8) Outline conforms to JEDEC outline TO-252AA

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